# 产品规格承认书

## **SPECIFICATIONS**

客户:

CUSTOMER:					
产品名称: DESCRIPTION: 客户型号:		地磁天线			
CUSTOMER PART NO:					
产品型号:					
OUR MODEL NO:	P	BX1608MA	02		
日期:					
DATE:		2021/09/01			
确认签字,盖章后请返 PLEASE RETURN TO WITH YOUR APPROVE	US ONE CO	PY OF "SPEC	IFICATIO	ON FOR APPROVA	L <b>"</b>
核准	审核	刘飞	制作	刘小美	
客户承认领	签印				
日期					
UNLESS OTHER SPECIFIED TOLE  X=± X.X=± X.XX=  ANGLES = ± HOLEI	=	PENGBANXING	深圳市	5朋伴兴业科技有	限公司
SCALE: N/A UNIT: r	nm			ICATIONS ARE THE PROPEI ALL NOT BE REPRODUCED	
	ED BY: XD ED BY: XD		THE MANUF	ACTURE OR SALE OF API	
TITLE: CHIP2450-1608 Specificati	on	DOCUMENT NO.		1608	SPEC REV.

#### **PBX1608MA01 Specification**

Operating Temp. : -40 ℃~+85 ℃

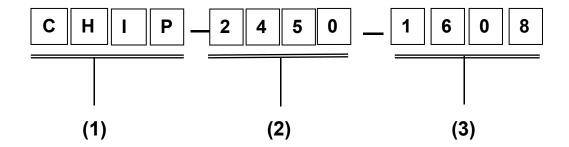
#### 1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

#### 2. APPLICATIONS:

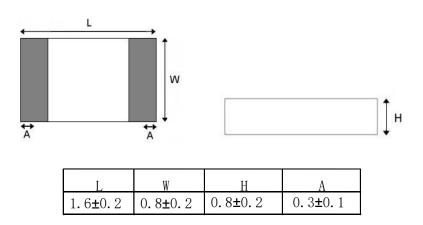
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

#### 3. PRODUCT IDENTIFICATION



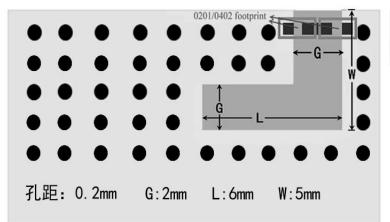
- (1) Product type: Multilayer chip Antenna
- (2) Center Frequency: 2450MHz
- (3) External Dimensions (L×W) (mm): 1.6\*0.8

#### 4. SHAPE AND DIMENSIONS:

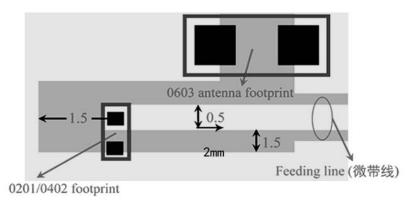


UNLESS OTHER SPECIFICATION X=± X.X=± ANGLES = ±	FIED TOLERANCES ON:  X.XX=  HOLEDIA = ±	深圳市朋伴兴业科技有限		限公司
SCALE: N/A	UNIT: mm	THESEDRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PB		
DRAWN BY : Sera	CHECKED BY: XD	TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS		
DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
TITLE: CHIP2450-1608 Specification		DOCUMENT	1608	SPEC REV.
TITLE: Chir2450-1606 Specification		NO.	1000	P1

●天线位于 PCB 板内部或中间位置时(长条式耳机): (单位: mm)

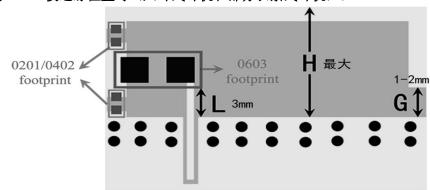






天线最优放置于中间区域,净空区周围最优需要至少一排过孔。

●天线位于 PCB 板边缘位置时(入耳式耳机和部分长条式耳机):

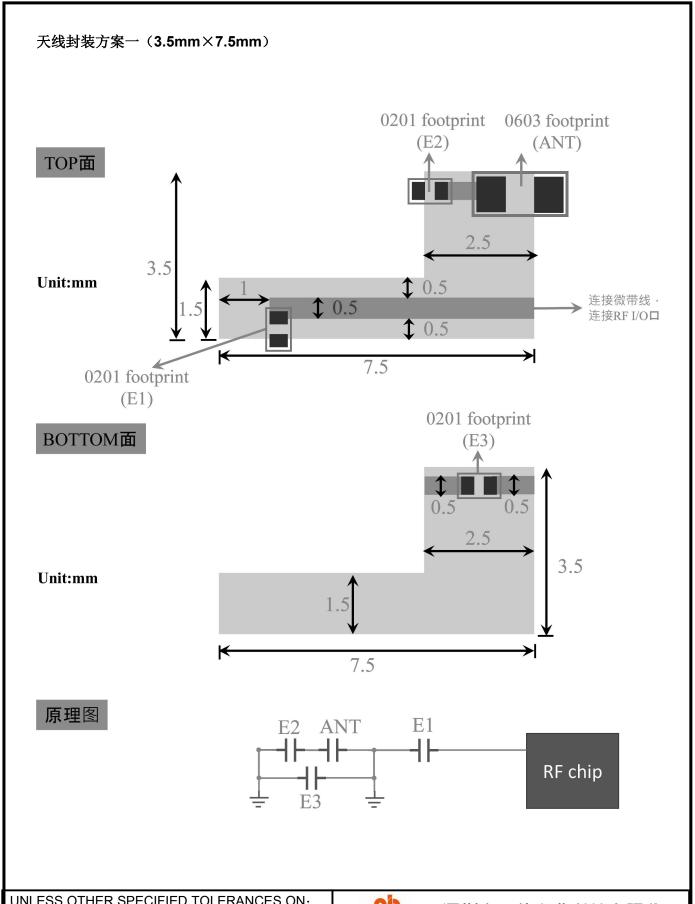


天线最优放置于 PCBA 的边缘; 天线及其走线设置在单层。

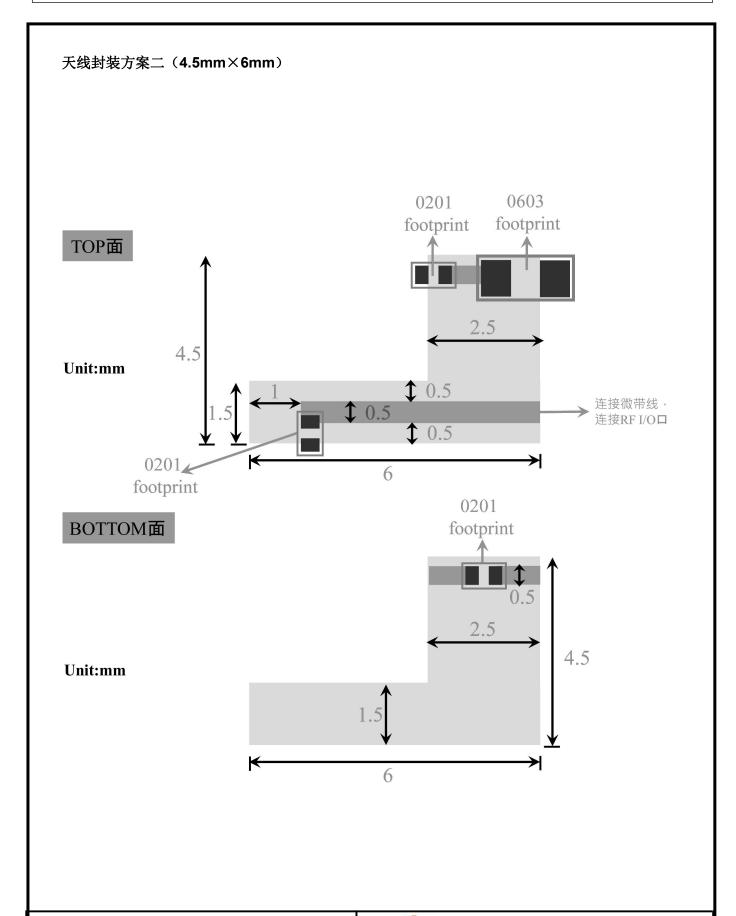
#### 设计标准:

- 1. 图中的尺寸仅作为参考;实际尺寸会根据不同版型进行优化。
- 2. 净空区周围最优需要至少一排过孔, 孔径 0.3mm, 与 PCBA 上的其它回路或物料进行隔离。

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SCALE: N/A	UNIT: mm	THESEDRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PI		TY OF PBXY
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DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
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DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
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TITLE: CHIF2430-1000	Specification	NO. 1006		P1

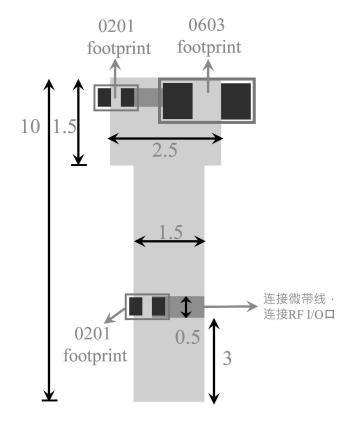


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DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
TITLE: CHIP2450-1608 Sp	acification	DOCUMENT 1608		SPEC REV.
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### 天线封装方案三(1.5mm×10mm)

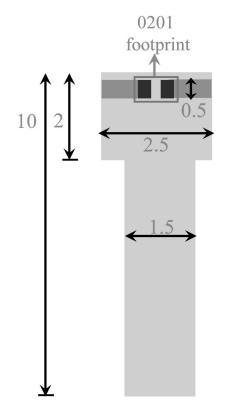
TOP面

Unit:mm



BOTTOM面

Unit:mm

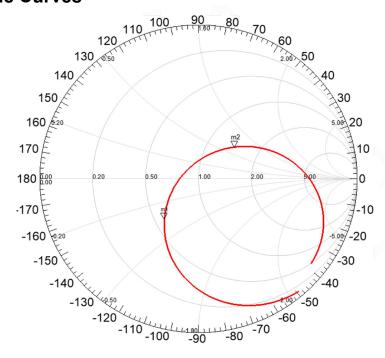


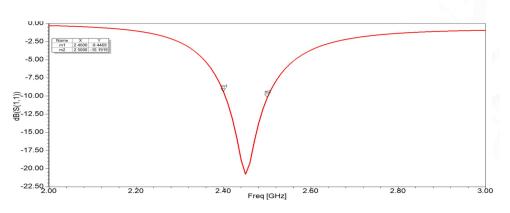
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SCALE: N/A	UNIT: mm	THESEDRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PE		
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TITLE: CHIP2450-1608 Specification		DOCUMENT	1608	SPEC REV.
TITLE: CHIP2450-1606 Specification		NO.	1000	D4

## **Electrical Characteristics**

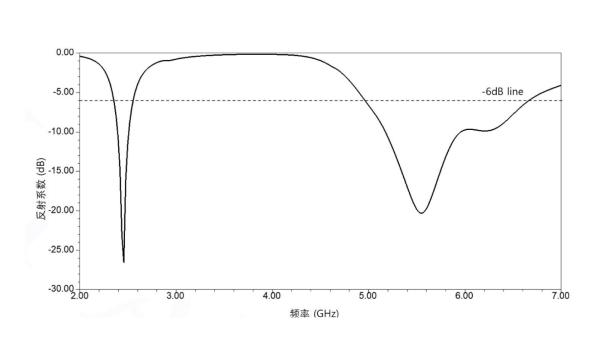
	Feature	Specification
1	Frequency	2402-2480MHz
2	Bandwidth	>100MHz
3	Peak gain	≤3dBi
4	VSWR	<2
5	Polarization	Linear
6	Azimuth beamwidth	Omnidirectional
7	Impedance	50 Ω

#### **Characteristic Curves**

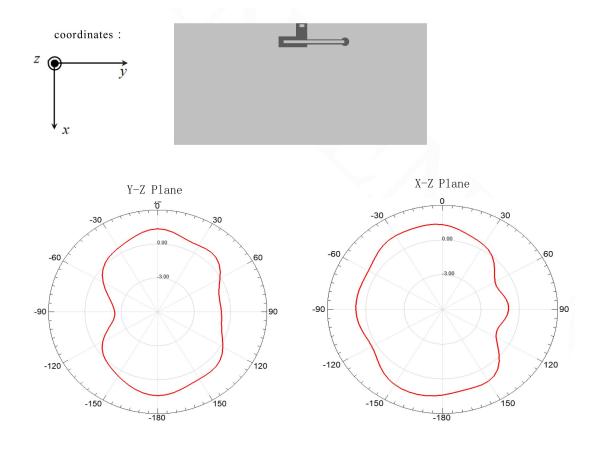




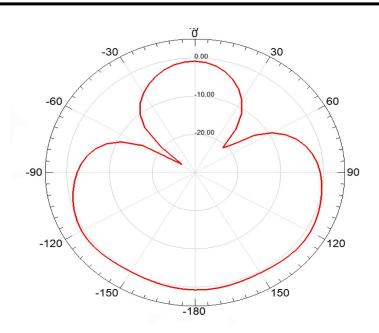
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DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
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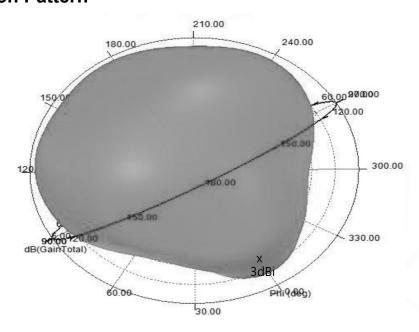
## **Radiation Pattern**



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DESIGNED BY: Sera	APPROVED BY: XD	DEVICES WITHOUT PERMISSION		
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## **3D Radiation Pattern**

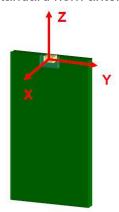


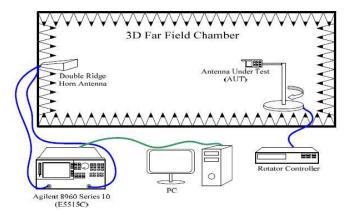
Frequency	2450MHz	5500MHz
Avg. gain	-0.85	-1.30
Peak gain	3.0	3.5
Efficiency	82%	78%

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TITLE: CHIP2450-1608 Specification		NO.	1000	P1

#### **Radiation Pattern**

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator,a standard horn antenna and Vector Network Analyzer is used to collect data.





#### **Environmental Characteristics**

#### (1) Reliability Test

Item	Condition	Specification
Thermal shock	1. $30\pm3$ minutes at $-40^{\circ}$ C $\pm5^{\circ}$ C, 2. Convert to $+105^{\circ}$ C (5 minutes) 3. $30\pm3$ minutes at $+105^{\circ}$ C $\pm5^{\circ}$ C, 4. Convert to $-40^{\circ}$ C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	<ol> <li>Humidity: 85% R.H.</li> <li>Temperature: 85±5° C</li> <li>Time: 1000 hours.</li> </ol>	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: 150° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
	1. Temperature: -40° C±5° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
	1. Solder bath temperature : $260\pm5^{\circ}\!$	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm5^\circ\!$	No apparent damage

#### (2) Storage Condition

#### (a) At warehouse:

The temperature should be within  $0 \sim 30^{\circ}\text{C}$  and humidity should be less than 60% RH. The product should be used within 1 year from the time of delivery.

#### (b) On board:

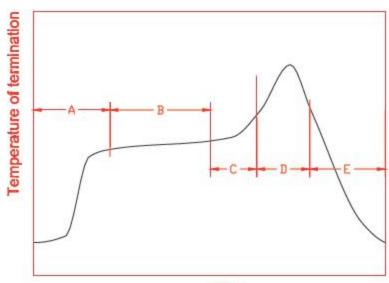
The temperature should be within -40~85°C and humidity should be less than 85% RH.

#### (3) Operating Temperature Range

Operating temperature range :  $-40^{\circ}$ C to  $+105^{\circ}$ C.

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			1000	P1		

## 8. Recommended Reflow Soldering



#### Time

Α	1 <sup>st</sup> rising temperature	The normal to Preheating temperature	30s to 60s	
В	Preheating	140°C to 160°C	60s to 120s	
С	2 <sup>nd</sup> rising temperature	Preheating to 200°C	20s to 40s	
D		if 220°C	50s~60s	
		if 230°C	40s~50s	
	Main heating	if 240°C	30s~40s	
		if 250°C	20s~40s	
		if 260°C	20s~40s	
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s	
_	20,20			

<sup>\*</sup>reference: J-STD-020C

#### (1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

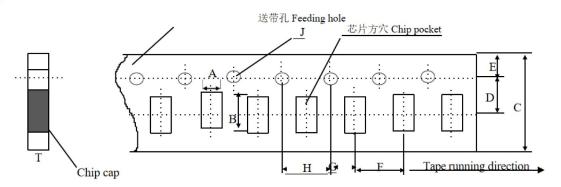
- (a) The tip temperature must be less than  $350^{\circ}\,$  C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

#### (2) Soldering Volume

Note that excess of soldering volume will easily get crack the body of this product.

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$ANGLES = \pm$	$HOLEDIA = \pm$					
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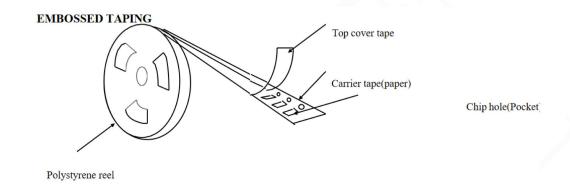
## Dimensions of paper taping:



Unit: mm

代号Code 纸带规格 papersize	A	В	С	D*	E	F	G*	Н	J	Т
+	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
尺寸	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



## **Storage Period**

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature:  $5\sim40^{\circ}\text{C}$  /Relative Humidity:  $20\sim70\%$ 

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